









PRODUCT DATASHEET



- ► EMC 2-PIN SMD
- ➤ 3020 0.52t Series
- ► Red (615-630nm)

NOR20S57



3020 0.52t Series





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APPLICATIONS:

- **Decorative Lighting**
- Portable Lighting
- **Outdoor Lighting**
- **Commercial Lighting**
- **Architectural Lighting**

FEATURES:

- Package: TOP View EMC White SMT Package
- Forward Current: 150mA Forward Voltage (typ.): 2.2V
- Luminous Flux (typ.): 17lm@150mA
- Colour: Red
- Wavelength: 615-630nm
- Viewing angle: 120°
- **Materials:**
 - Die: AlGaInP
 - Resin: Silicon (Water Clear)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C Storage Temperature: -40~+105°C
- **Grouping parameters:**
 - Forward Voltage
 - Luminous Flux
 - **Dominant Wavelength**
- Soldering methods: Reflow
- Preconditioning: MSL3 according to J-STD020
- Packing: 8mm tape with Max.5000pcs/reel, ø180mm (7")



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	l _F	200	mA
PULSE Forward Current	IFP	300	mA
Powewr Dissipation	P _D	520	mW
Reverse Voltage	VR	5	V
Reverse Current @5V	I _R	10	μΑ
Junction Temperature	Tj	110	°C
Electrostatic Discharge (HBM: MIL-STD-883 C 2)	ESD	2000	V
Thermal Resistance	Rthj-sp	16	°C/W
Operating Temperature	T_{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+105	°C
Soldering Temperature (10S)	T _{SOL}	230 or 260 for 10S	°C

Electrical & Optical Characteristics (Ta=25°C)

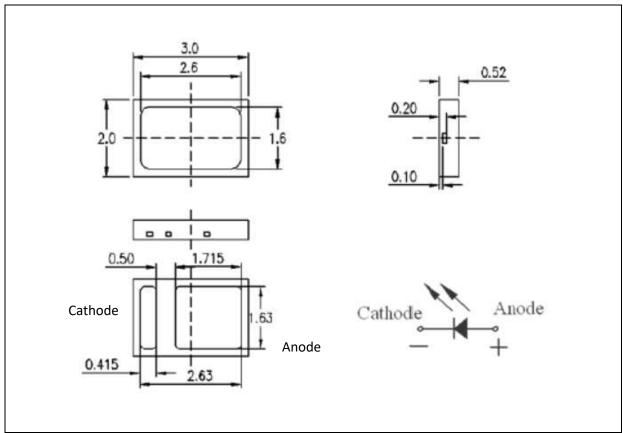
Darameter	Symbol	Values			Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	V_{F}	1.8	2.2	2.6	V	I _F =150mA
Luminous Flux	Ф۷	14	17	26	lm	I _F =150mA
Dominant Wavelength	λ_{D}	615		630	nm	I _F =150mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =150mA

^{1.} Luminous flux (Φ_V) ±7%, Forward Voltage (V_F) ±0.05V, Viewing angle($2\theta_{1/2}$) ±10°



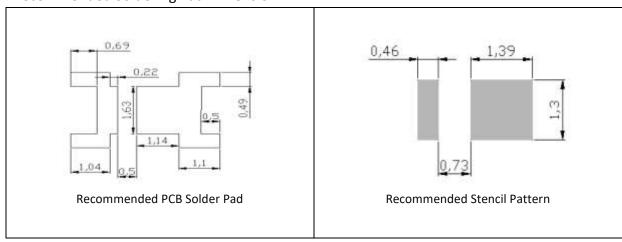
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.12mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 150mA):

Code	Min.	Max.	Unit
V1820	1.8	2.0	
V2022	2.0	2.2	V
V2224	2.2	2.4	V
V2426	2.4	2.6	

Luminous Flux Classifications (I_F = 150mA):

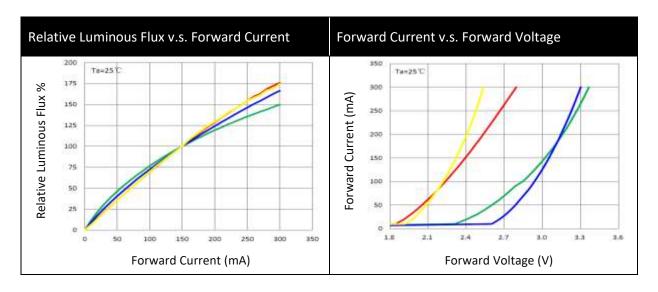
Code	Min.	Max.	Unit
AG	14	18	
АН	18	22	lm
AJ	22	26	

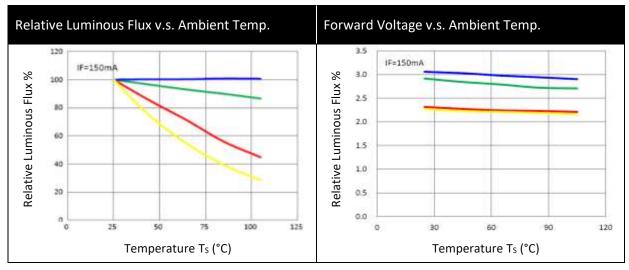
Dominant Wavelength Classifications (I_F = 150mA):

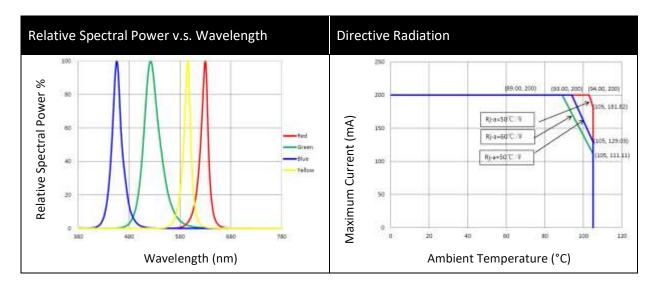
Code	Min.	Max.	Unit
R615	615	620	
R620	620	625	nm
R625	625	630	



ELECTRO-OPTICAL CHARACTERISTICS:



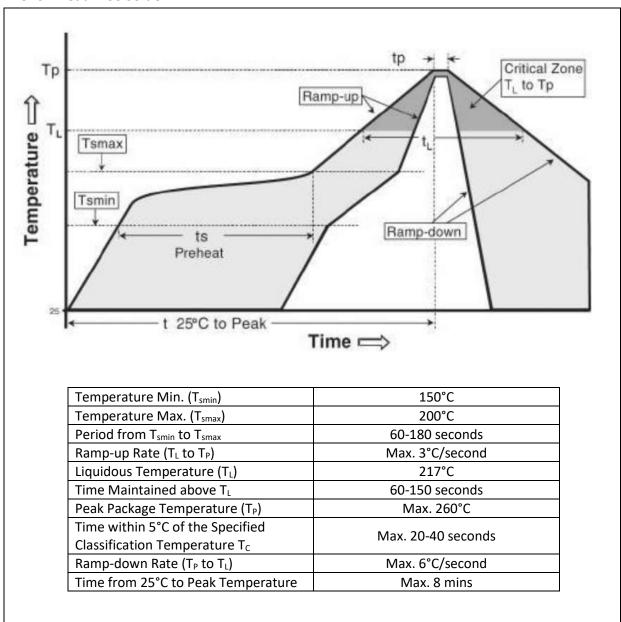






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



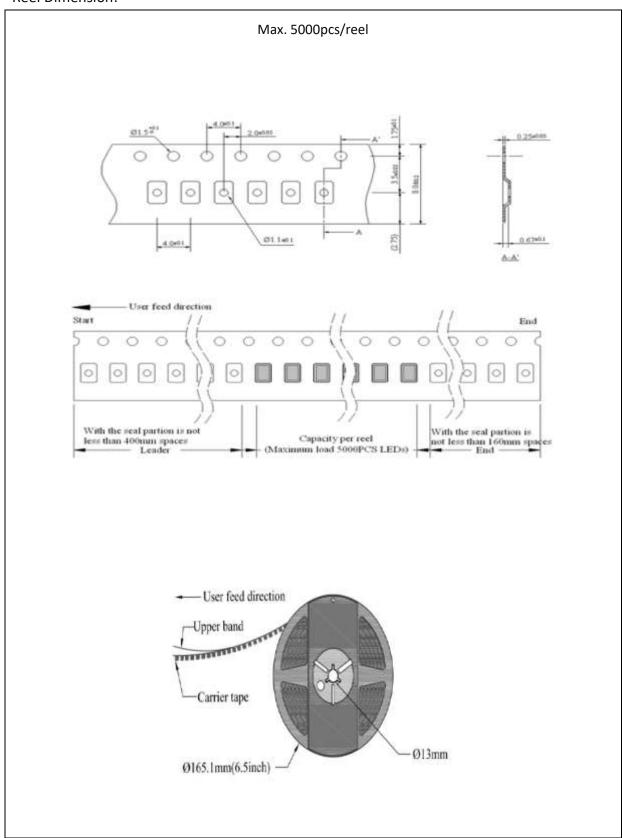
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

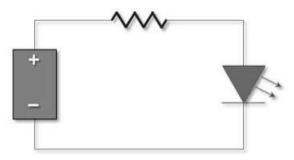
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	28/01/2017	Datasheet set-up.
A1.1	30/03/2018	Lead frame upgrade.
A1.2	03/04/2018	Correct wrong polarity drawing from last revision.
A1.3	05/12/2018	Revise operating temperature range.